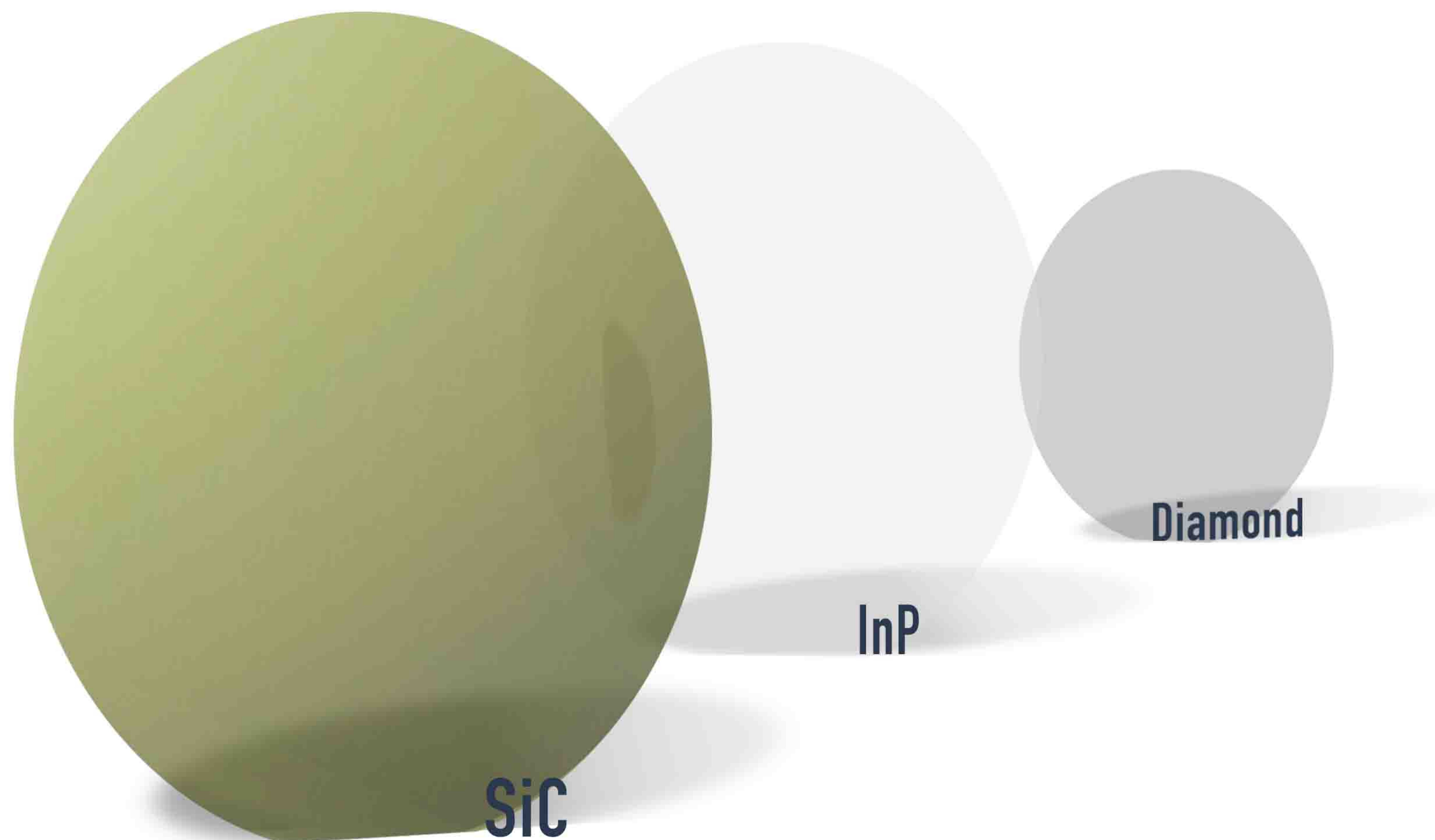


ZGYMZN

高温键合热压炉

High-temperature bonding hot press furnace



SEMICONDUCTOR MATERIAL PRODUCTION
EQUIPMENT MANUFACTURER



SGS

CE

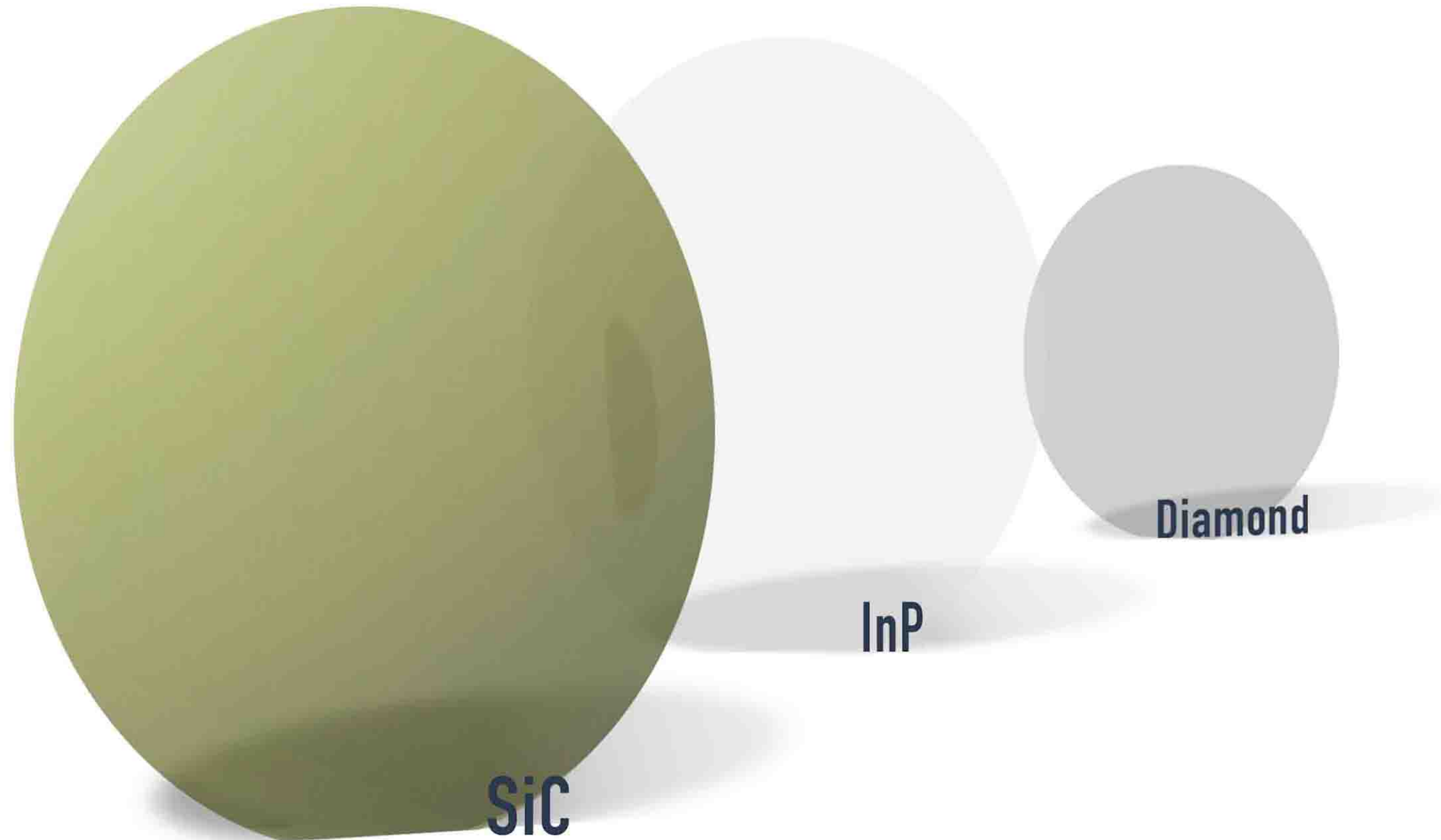
RoHS
COMPLIANT

SEMI S2

ZGYMZN

全自动喷胶机/匀胶机

Automatic glue spraying machine/Automatic Spin Coating Machine



SEMICONDUCTOR MATERIAL PRODUCTION
EQUIPMENT MANUFACTURER

SGS

CE

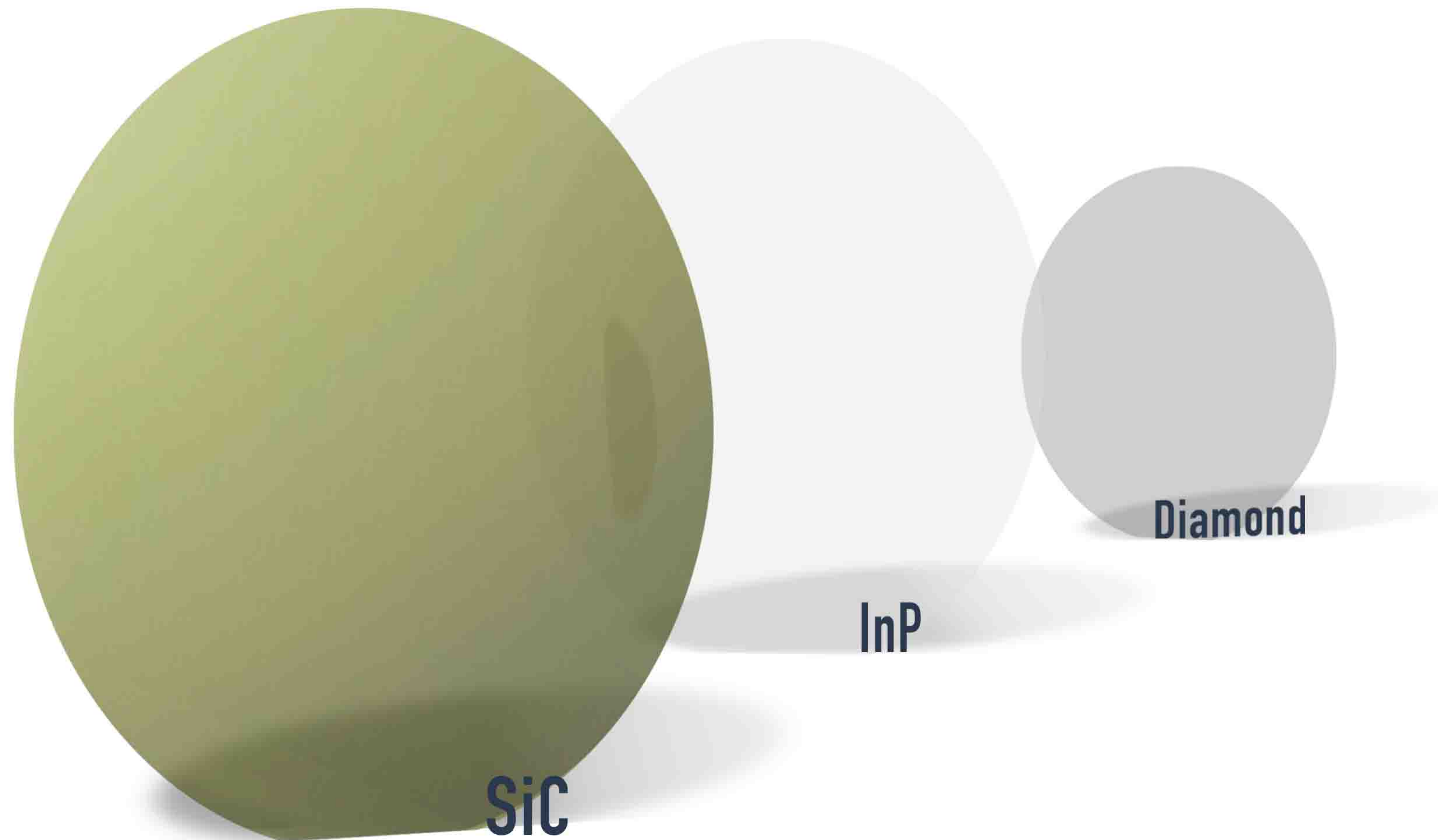
RoHS
COMPLIANT

SEMI S2

ZGYMZN

全自动清洗/刷洗/键合

Automatic cleaning/scrubbing/bonding



SEMICONDUCTOR MATERIAL PRODUCTION
EQUIPMENT MANUFACTURER



SGS

CE

RoHS
COMPLIANT

SEMI S2

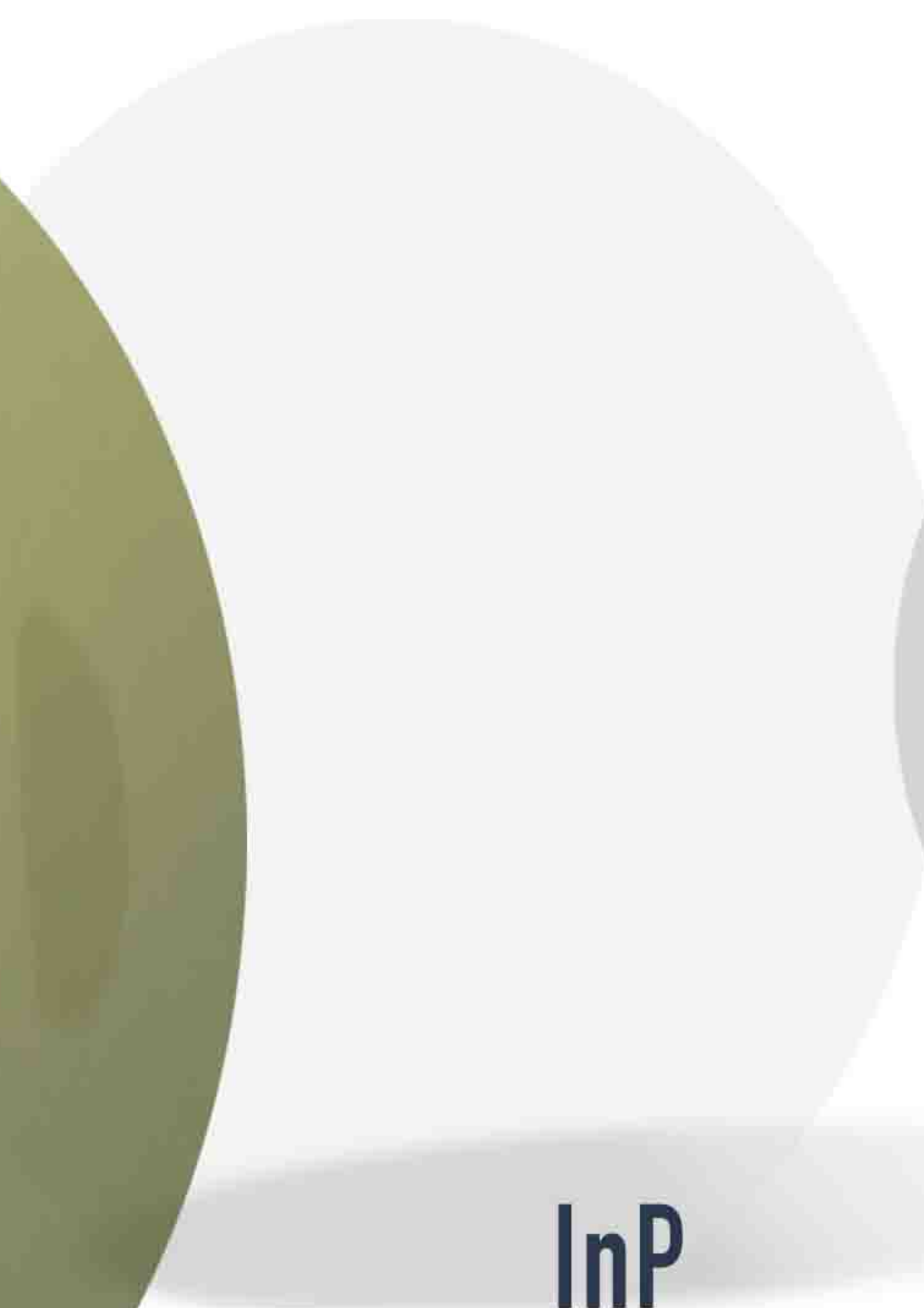
ZGYMZN

全自动籽晶粘接机

Automatic seed crystal bonding machine



SiC



InP



Diamond



SEMICONDUCTOR MATERIAL PRODUCTION
EQUIPMENT MANUFACTURER

SGS

CE



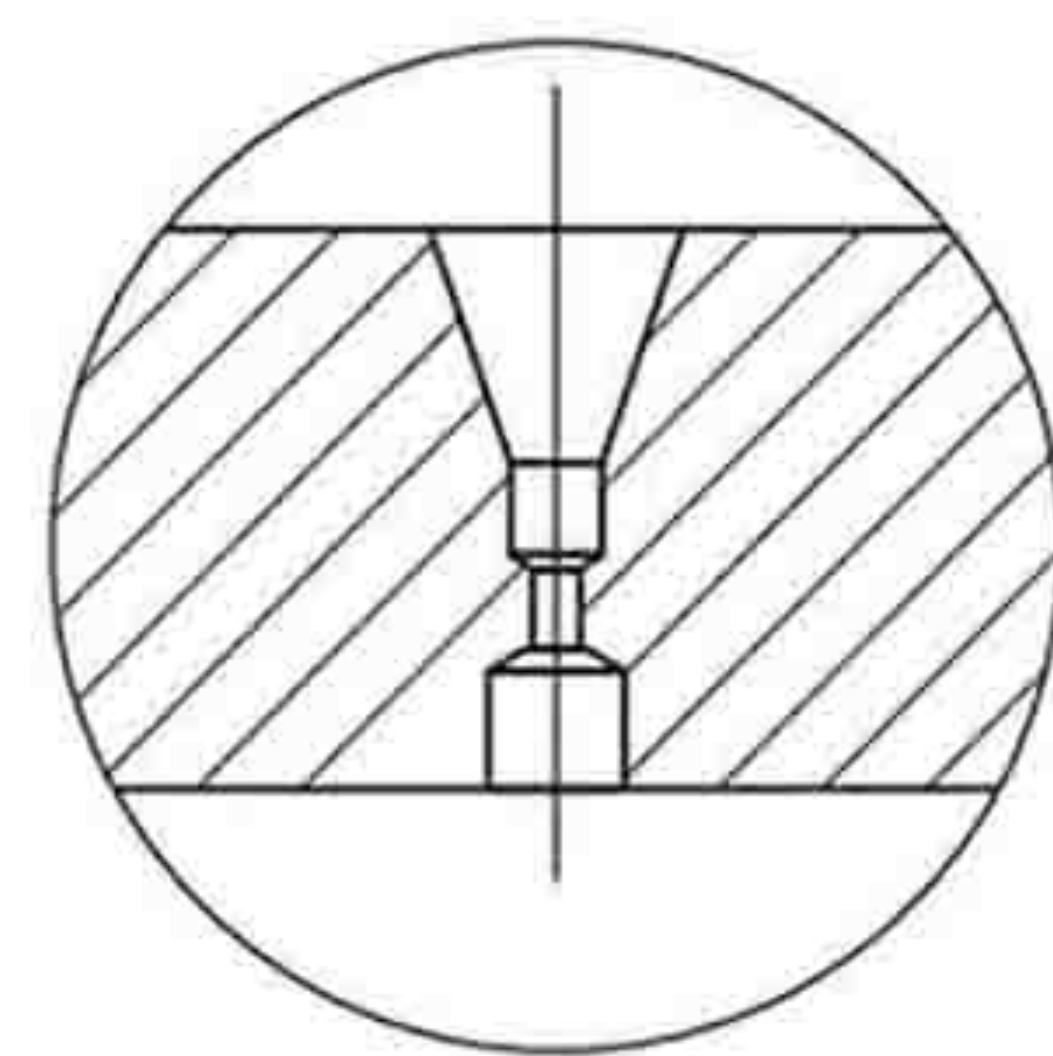
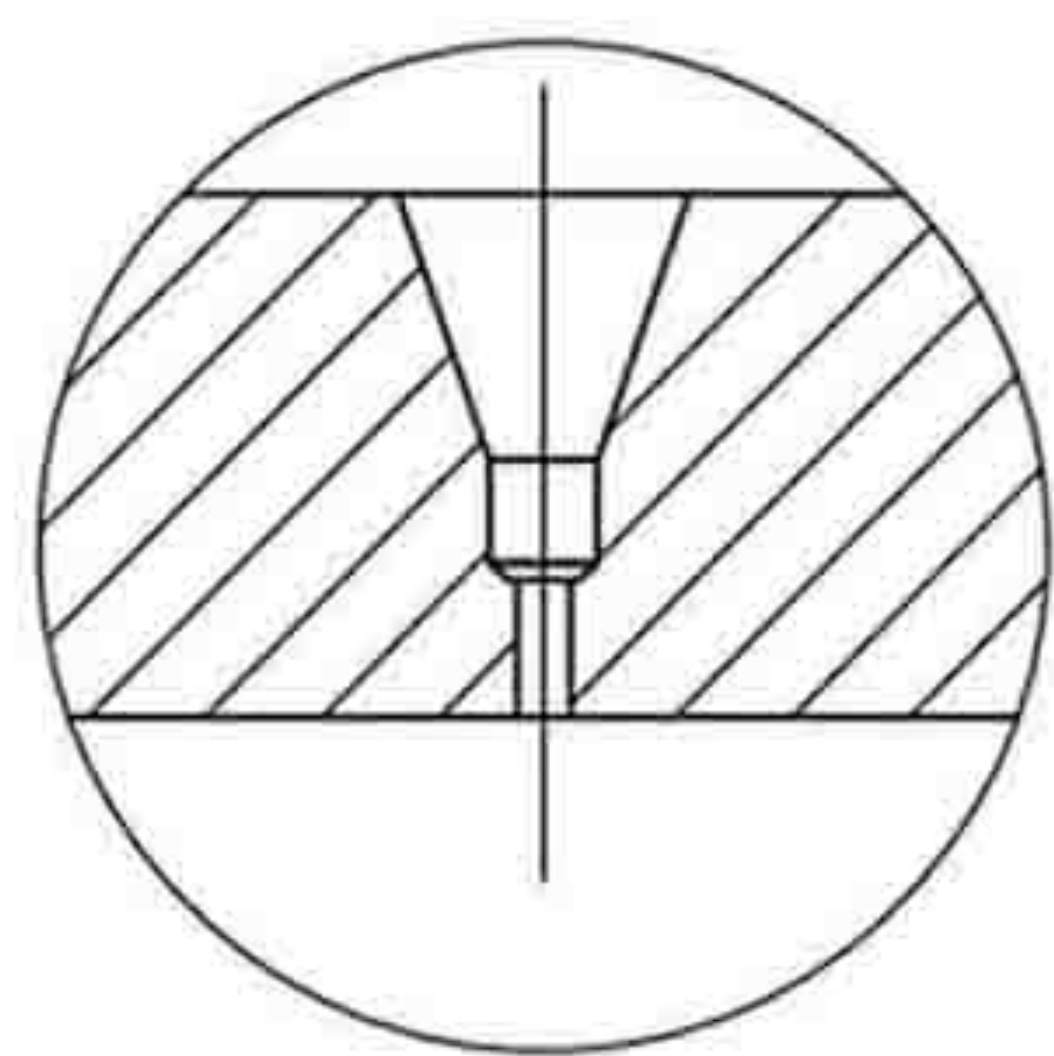
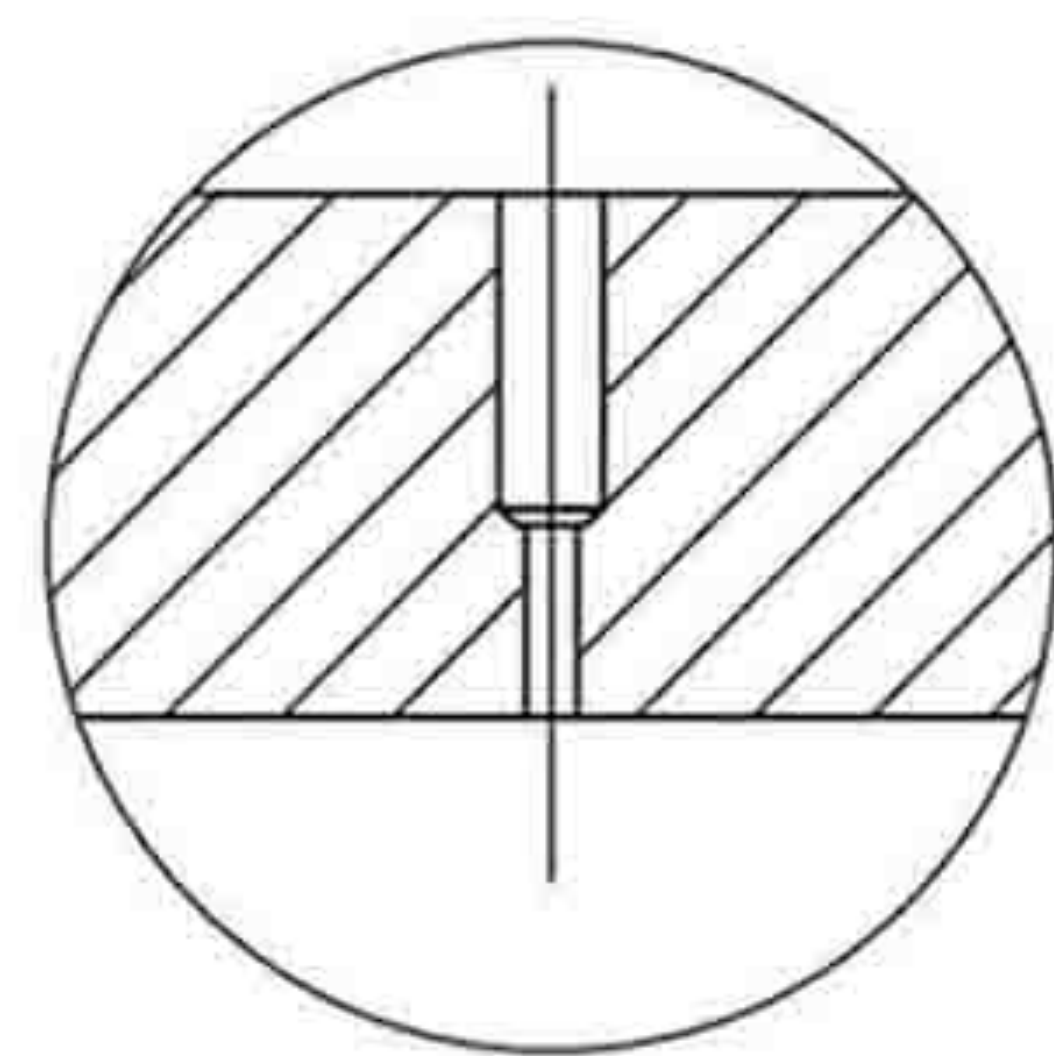
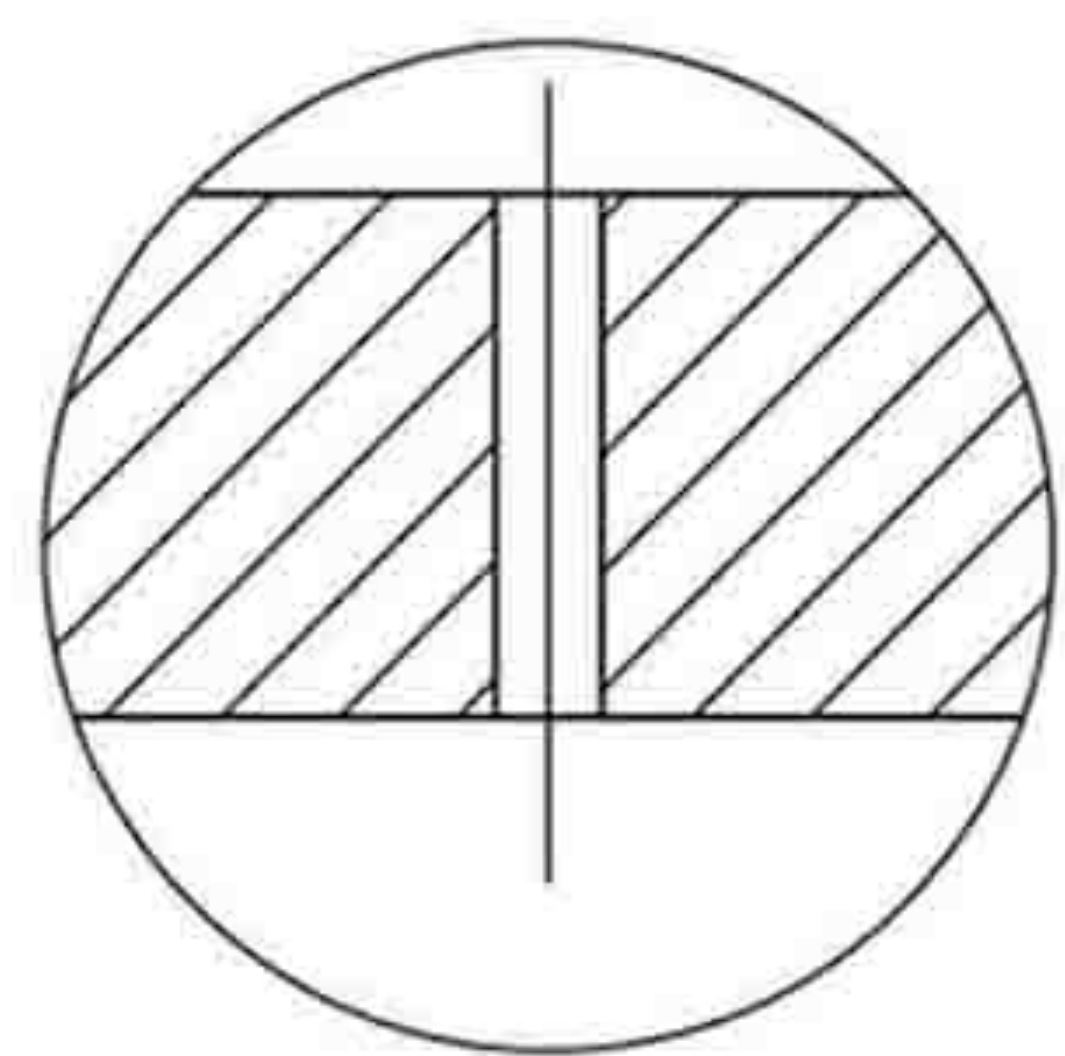
RoHS
COMPLIANT

SEMI S2

ZGYMZN

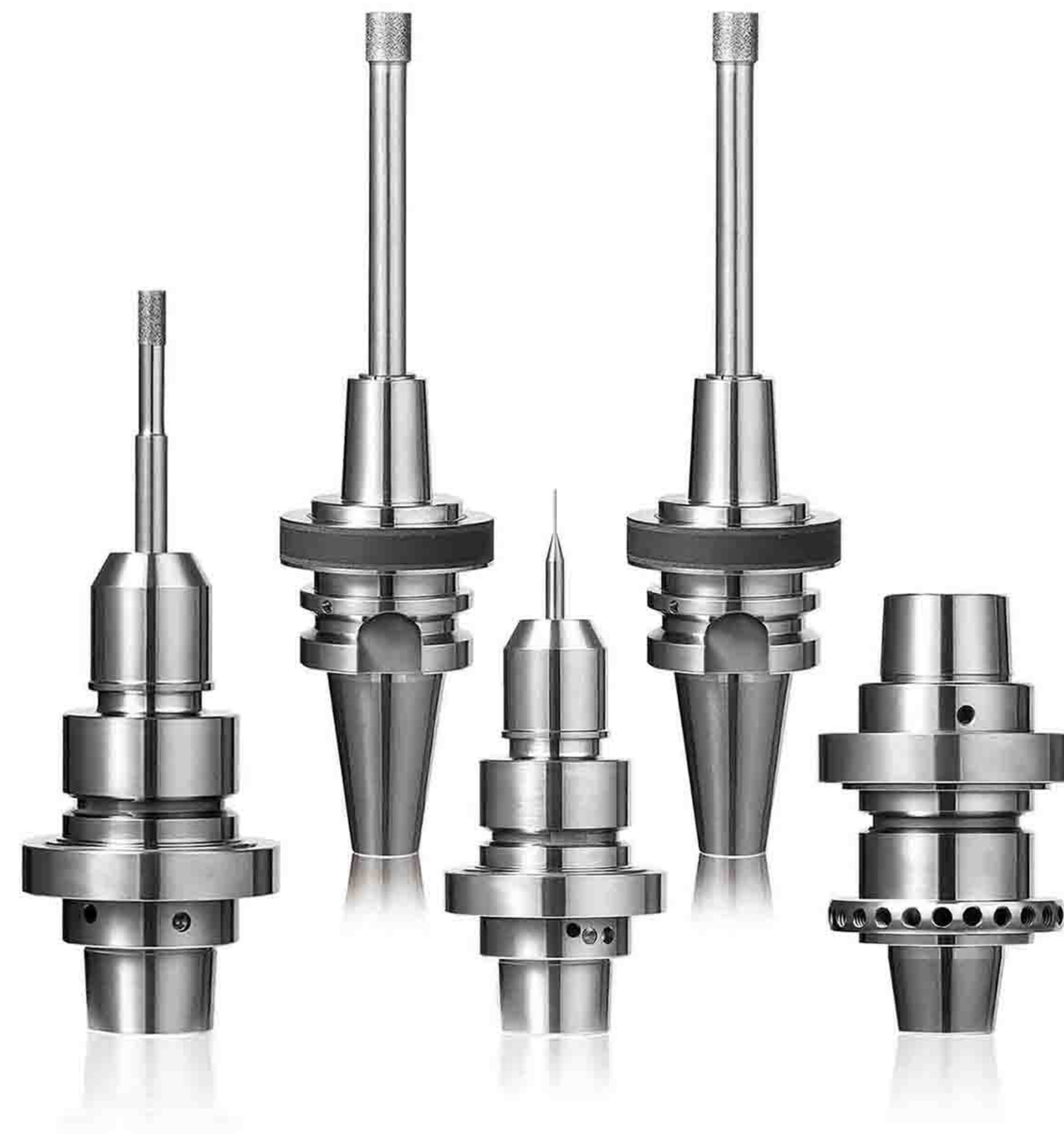
Solid SiC 超声加工

Solid SiC Ultrasonic Machining



喷淋头 Showerhead

- 孔口崩边: $\leq 0.03\text{mm}$
- 效率提升: 40%~150%
- 刀具寿命提升: 100%~160%
- 同盘孔径波动: $\leq \pm 3\mu\text{m}$
- Orifice chipping: $\leq 0.03\text{mm}$
- Efficiency improvement: 40%~150%
- Tool life improvement: 100%~160%
- Diameter variation within the same disk: $\leq \pm 3\mu\text{m}$



SGS

CE

RoHS
COMPLIANT

SEMI S2